



## Final Product Change Notification

201203009F01

**Issue Date:** 24-Jul-2013

**Effective Date:** 22-Oct-2013

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# QUALITY

### Management Summary

Final announcement of products processed in PM72 transferred within NXP Nijmegen from ICN6 to ICN8 due to factory closure

### Change Category

Wafer Fab process	Assembly Process	Product Marking	Design
Wafer Fab materials	Assembly Materials	Electrical spec./Test coverage	Mechanical Specification
Wafer Fab location	Assembly Location	Test Location	Packing/Shipping/Labeling

## Transfer PM72 process from ICN6 to ICN8 within NXP Nijmegen (The Netherlands)

### Details of this Change

Transfer within NXP Nijmegen (The Netherlands) from ICN6 (PM72 process) to ICN8 (PC110DMB/TM process)

- Process and products will be transferred in 2013, production ramp down and closure of ICN6 planned 1 January 2014
- No change in die layout, all masks are produced from the same GDS2 file
- No change in ordering code 12NC's and product type number

### Why do we Implement this Change

- Move production to 8" wafers

- Capacity increase to address customer demand

#### Identification of Affected Products

Applied wafer fab is indicated on the third line of the product marking (top side) first character, if space permits:

"U"= NXP ICN6

"T"= NXP ICN8

#### Product Availability

##### Sample Information

Samples are available upon request

Requested customer engineering' samples based on the APCN 201203009A will be available type by type.

##### Production

Planned first shipment 05-Oct-2013

#### Impact

- No impact
- No change in data sheet, form, fit, function, quality or reliability anticipated

##### Data Sheet Revision

No impact to existing datasheet

##### Disposition of Old Products

Existing inventory will be shipped until depleted

#### Related Notifications

Notification Issue	Date Effective	Date	Title
201203009A	27-Jun-	2012	Transfer PM72 process from ICN6 to ICN8 within NXP Nijmegen (The Netherlands)

#### Timing and Logistics

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 23-Aug-2013.

#### Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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